

Xinyi Zhang

xinyiz0931@gmail.com

<https://xinyiz0931.github.io/>

EDUCATION

Ph. D. in Engineering **04/2020 – 09/2023**

Graduate School of Engineering Science, Osaka University, Japan

Advisor: Prof. Kensuke Harada

Master of Engineering **04/2018 – 03/2020**

Graduate School of Engineering Science, Osaka University, Japan

Advisor: Prof. Kensuke Harada

Bachelor **09/2012 – 07/2016**

Information Management and Information System, Tianjin University, China

WORK EXPERIENCE

Researcher **10/2023 - Present**

Sony R&D

PUBLICATIONS

Journal Paper (Peer-Reviewed)

- [1] **Xinyi Zhang***, Yukiyasu Domae, Weiwei Wan, Kensuke Harada A Closed-Loop Bin Picking System for Entangled Wire Harnesses using Bimanual and Dynamic Manipulation. Robotics and Computer-Integrated Manufacturing, 2023. [webpage](#), [paper](#).
- [2] **Xinyi Zhang***, Yukiyasu Domae, Weiwei Wan, Kensuke Harada. Learning to Dexterously Pick or Separate Tangled-Prone Parts for Industrial Bin Picking. IEEE Robotics and Automation Letters (RA-L), 2023. [webpage](#), [paper](#).
- [3] **Xinyi Zhang***, Yukiyasu Domae, Weiwei Wan, Kensuke Harada. Learning a Sequential Policy of Efficient Actions for Tangled-Prone Parts in Robotic Bin Picking. IEEE Robotics and Automation Letters (RA-L), 2022. (Presented at ICRA 2023). [webpage](#), [paper](#).
- [4] Kaidi Nie, Felix von Drigalski, Joshua C. Triyonoputro, Chisato Nakashima, Yoshiya Shibata, Yoshinori Konishi, Yoshihisa Ijiri, Taku Yoshioka, Yukiyasu Domae, Toshio Ueshiba, Ryuichi Takase, **Xinyi Zhang**, Damien Petit, Ixchel G. Ramirez-Alpizar, Weiwei Wan & Kensuke Harada. Team O2AS' approach for the task-board task of the World Robot Challenge 2018. Advanced Robotics, 2020. [paper](#).

International Conferences (Peer-Reviewed)

- [5] Mizuki Takasu, **Xinyi Zhang***, Yukiyasu Domae, Weiwei Wan, Kensuke Harada. Industrial Bin Picking of Potential Entangled Objects in Dense Clutter by Skeletonized Shape Restoration. 18th International Symposium on Experimental Robotics (ISER), 2023.

- [6] **Xinyi Zhang***, Keisuke Koyama, Yukiyasu Domae, Weiwei Wan, Kensuke Harada. A Topological Solution of Entanglement for Complex-shaped Parts in Robotic Bin-picking. IEEE International Conference on Automation Science and Engineering (CASE), 2021. ([IEEE Robotics and Automation Society Japan Joint Chapter Young Award](#)). [paper](#).

Domestic Conferences

- [7] **Xinyi Zhang**, Weiwei Wan, Yukiyasu Domae, Kensuke Harada. Initial Experiments on Picking Entangled Wire Harnesses using Dynamic Manipulation. ROBOMECH2023.
- [8] Mizuki Takasu, **Xinyi Zhang**, Yukiyasu Domae, Weiwei Wan, Kensuke Harada. Bin-Picking for Potential Entangled Object by Linearing Image of the Pile. SI2022. ([Best Presentation Award](#))
- [9] **Xinyi Zhang**, Weiwei Wan, Yukiyasu Domae, Kensuke Harada. Learning Dexterous Bin Picking Policies for Picking and Separating Tangled-Prone Parts. RSJ2022.
- [10] **Xinyi Zhang**, Yukiyasu Domae, Weiwei Wan, Kensuke Harada. Efficiently Picking Tangled-Prone Parts by Learning a Sequential Bin Picking Policy. SICE SI2021. ([Best Presentation Award](#))
- [11] **Xinyi Zhang**, Keisuke Koyama, Yukiyasu Domae, Weiwei Wan, Kensuke Harada. Topology-based Grasp Detection Avoiding Entanglement for Robotic Bin-picking. SI2020. ([Young Scientist Incentive Award](#), [Best Presentation Award](#))
- [12] **Xinyi Zhang**, Keisuke Koyama, Weiwei Wan, Yukiyasu Domae, Kensuke Harada. Motion Generation for Separating Tangled Objects in Robotic Bin-picking. SCI'20.
- [13] **Xinyi Zhang**, Damien Petit, Yukiyasu Domae, Ixchel G. Ramirez-Alpizar, Weiwei Wan, Kensuke Harada. Error Analysis and Adjustment on Randomized Bin-picking. SI2019.
- [14] **Xinyi Zhang**, Damien Petit, Yukiyasu Domae, Ixchel G. Ramirez-Alpizar, Weiwei Wan, Kensuke Harada. A Real-time Robotic Calibration Method for Vision-based Bin-picking. ROBOMECH2019.

PATENTS

- [1] 原田研介, **張馨藝 (Xinyi Zhang)**, 堂前幸康, 万偉偉, 森建郎. ワーク取出し装置. 特開 2023-095329, 2023.
- [2] 原田研介, 万偉偉, 堂前幸康, **張馨藝 (Xinyi Zhang)**, 森建郎, 吹田和嗣, 五十嵐淳. ワーク取り出し装置、ワーク取り出し方法、プログラム及び制御装置. 特開 2021-186542, 2021.

AWARDS AND HONORS

Best Presentation Award (優秀講演賞) SICE SI2021	12/2021
Young Scientist Incentive Award (若手奨励賞) SICE SI Division	12/2021
Japan Joint Chapter Young Award (IROS, CASE2021) IEEE Robotics and Automation Society	10/2021
Scholarship Kobayashi Foundation (公益財団法人小林財団)	04/2021 – 03/2023
Best Presentation Award (優秀講演賞)	12/2020

SICE SI2020